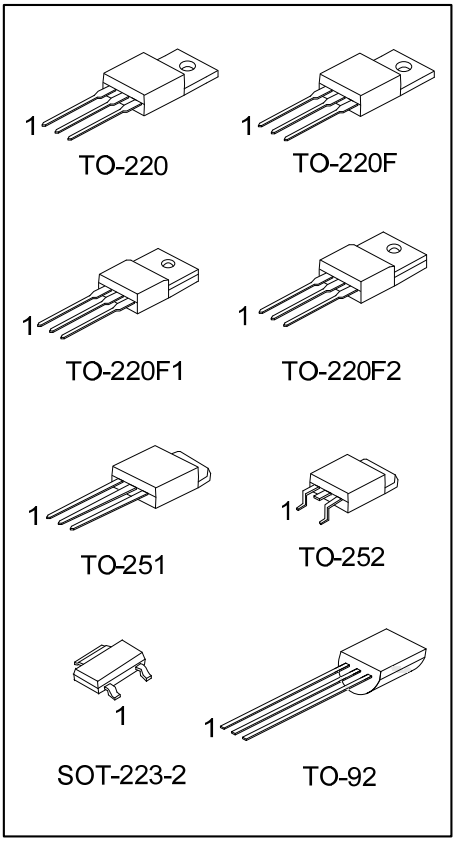
5.0A, 500V N-CHANNEL SUPER-JUNCTION MOSFET



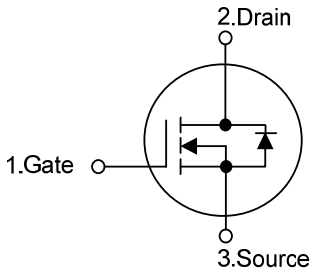
■ DESCRIPTION

The **UTC 5NM50A** is a Super Junction MOSFET Structure and is designed to have better characteristics, such as fast switching time, low gate charge, low on-state resistance and a high rugged avalanche characteristics. This power MOSFET is usually used at AC-DC converters for power applications.

■ FEATURES

* $R_{DS(ON)} \leq 0.9\ \Omega$ @ V_{GS}=10V, I_D=2.5A
* Fast Switching Capability
* Avalanche Energy Specified
* Improved dv/dt Capability, High Ruggedness

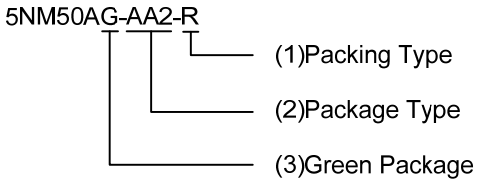
■ SYMBOL



■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
5NM50AL-AA2-R	5NM50AG-AA2-R	SOT-223-2	G	D	S	Tape Reel
5NM50AL-TA3-T	5NM50AG-TA3-T	TO-220	G	D	S	Tube
5NM50AL-TF1-T	5NM50AG-TF1-T	TO-220F1	G	D	S	Tube
5NM50AL-TF2-T	5NM50AG-TF2-T	TO-220F2	G	D	S	Tube
5NM50AL-TF3-T	5NM50AG-TF3-T	TO-220F	G	D	S	Tube
5NM50AL-TM3-T	5NM50AG-TM3-T	TO-251	G	D	S	Tube
5NM50AL-TN3-R	5NM50AG-TN3-R	TO-252	G	D	S	Tape Reel
5NM50AL-T92-B	5NM50AG-T92-B	TO-92	G	D	S	Tape Box
5NM50AL-T92-K	5NM50AG-T92-K	TO-92	G	D	S	Bulk

Note: Pin Assignment: G: Gate D: Drain S: Source

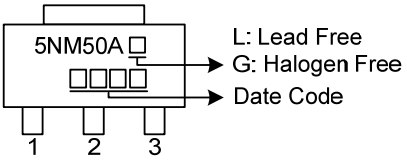
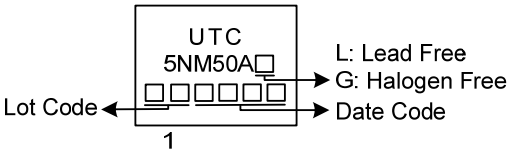
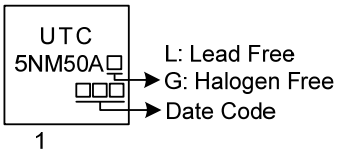


(1) R: Tape Reel, T: Tube, K: Bulk

(2) AA2: SOT-223-2, TA3: TO-220, TF3: TO-220F, TF1: TO-220F1, TF2: TO-220F2, TM3: TO-251, TN3: TO-252, T92: TO-92

(3) G: Halogen Free and Lead Free, L: Lead Free

■ MARKING

PACKAGE	MARKING
SOT-223	
TO-220 / TO-220F TO-220F1 / TO-220F2 TO-251 / TO-252	
TO-92	

■ ABSOLUTE MAXIMUM RATINGS (T_C = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V_{DSS}	500	V
Gate-Source Voltage		V_{GSS}	±30	V
Drain Current	Continuous	I_D	5	A
	Pulsed (Note 2)	I_{DM}	15	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	144	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	2.4	V/ns
Power Dissipation	SOT-223-2	P_D	4.2	W
	TO-220		31	W
	TO-220F/TO-220F1 TO-220F2		17	W
	TO-251/TO-252		21	W
	TO-92		3.6	W
Junction Temperature		T_J	+150	°C
Storage Temperature		T_{STG}	-55 ~ +150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating: Pulse width limited by maximum junction temperature.
3. L = 144mH, I_{AS} = 1.4A, V_{DD} = 50V, R_G = 25 Ω, Starting T_J = 25°C
4. I_{SD} ≤ 5.0A, di/dt ≤ 200A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C

■ THERMAL DATA

PARAMETER		SYMBOL	RATING	UNIT
Junction to Ambient	SOT-223-2	θ_{JA}	150	°C/W
	TO-220/TO-220F TO-220F1/TO-220F2		62.5	°C/W
	TO-251/TO-252		110	°C/W
	TO-92		160	°C/W
Junction to Case	SOT-223-2	θ_{JC}	29.76 (Note)	°C/W
	TO-220		4.03	°C/W
	TO-220F/TO-220F1 TO-220F2		7.35	°C/W
	TO-251/TO-252		5.95 (Note)	°C/W
	TO-92		34.72 (Note)	°C/W

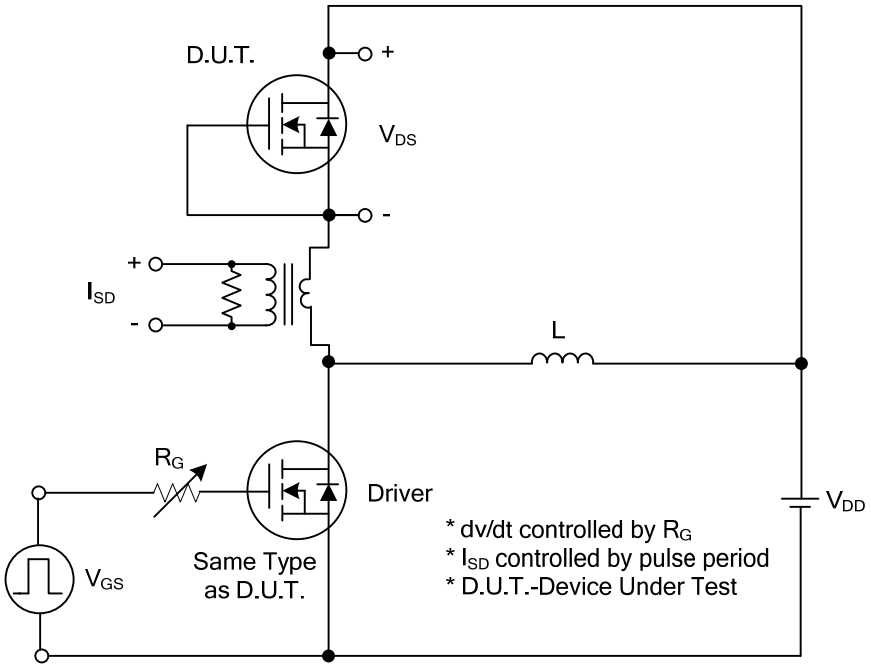
Note: Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate.

■ ELECTRICAL CHARACTERISTICS (T_J=25°C, unless otherwise specified)

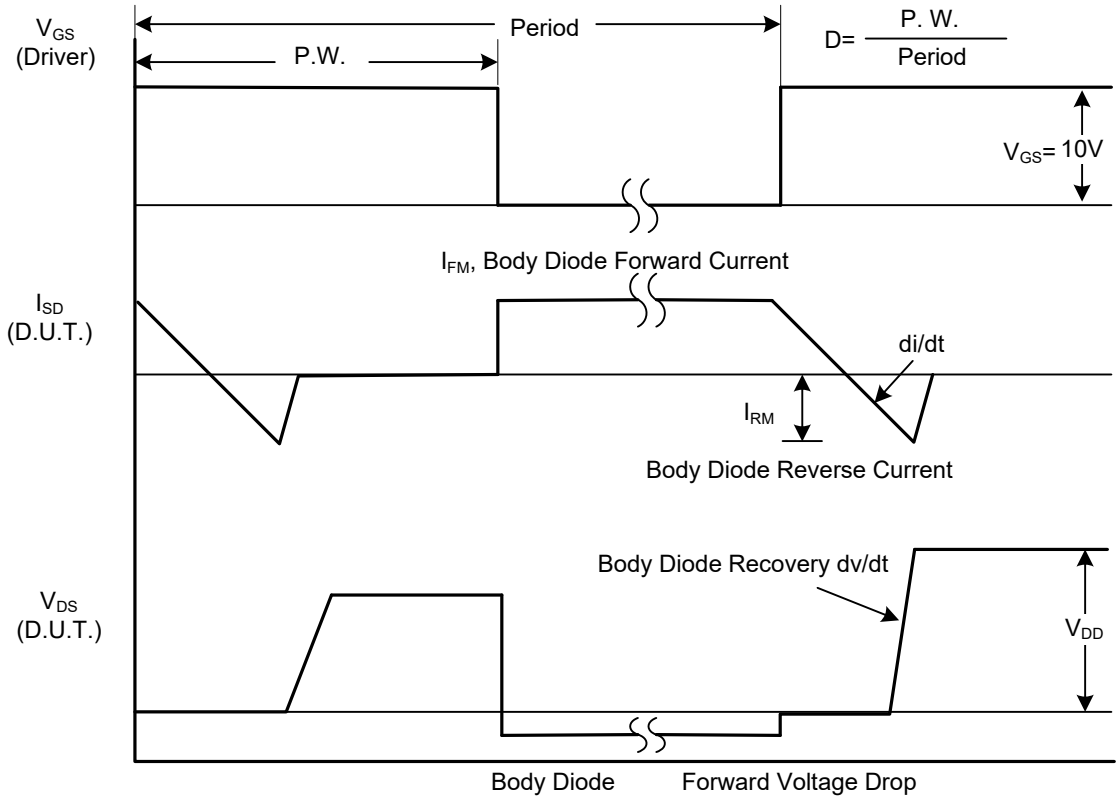
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	V_{GS}=0V, I_D=250μA	500			V
Drain-Source Leakage Current		I_{DSS}	V_{DS}=500V, V_{GS}=0V			10	μA
Gate-Source Leakage Current	Forward	I_{GSS}	V_{GS}=30V, V_{DS}=0V			100	nA
	Reverse		V_{GS}=-30V, V_{DS}=0V			-100	nA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	V_{DS}=V_{GS}, I_D=250μA	2.5		4.5	V
Static Drain-Source On-State Resistance		$R_{DS(ON)}$	V_{GS}=10V, I_D=2.5A			0.9	Ω
DYNAMIC CHARACTERISTICS							
Input Capacitance		C_{ISS}	V_{GS}=0V, V_{DS}=50V, f=1MHz		231		pF
Output Capacitance		C_{OSS}			114		pF
Reverse Transfer Capacitance		C_{RSS}			13		pF
SWITCHING CHARACTERISTICS							
Total Gate Charge (Note 1)		Q_G	V_{DS}=50V, V_{GS}=10V, I_D=2.5A (Note 1, 2)		17		nC
Gate to Source Charge		Q_{GS}			5		nC
Gate to Drain Charge		Q_{GD}			7		nC
Turn-ON Delay Time (Note 1)		$t_{D(ON)}$	V_{DS}=100V, V_{GS}=10V, I_D=5.0A, R_G=25Ω (Note 1, 2)		9		ns
Rise Time		t_R			22		ns
Turn-OFF Delay Time		$t_{D(OFF)}$			32		ns
Fall-Time		t_F			23		ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Body-Diode Continuous Current		I_S				5	A
Maximum Body-Diode Pulsed Current		I_{SM}				15	A
Drain-Source Diode Forward Voltage (Note 1)		V_{SD}	I_S=5.0A, V_{GS}=0V			1.4	V
Body Diode Reverse Recovery Time (Note 1)		t_{rr}	I_S=5.0A, V_{GS}=0V, dI_F/dt=100A/μs		196		ns
Body Diode Reverse Recovery Charge		Q_{rr}			1.5		μC

Notes: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 2%.
2. Essentially independent of operating temperature.

■ TEST CIRCUITS AND WAVEFORMS

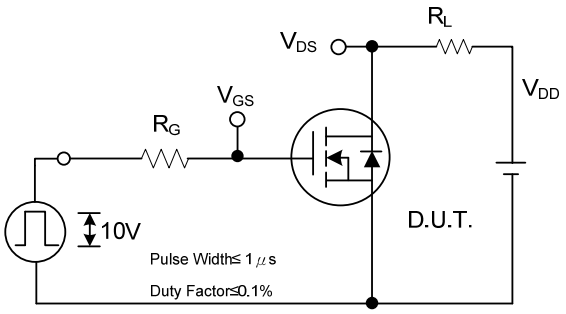


Peak Diode Recovery dv/dt Test Circuit

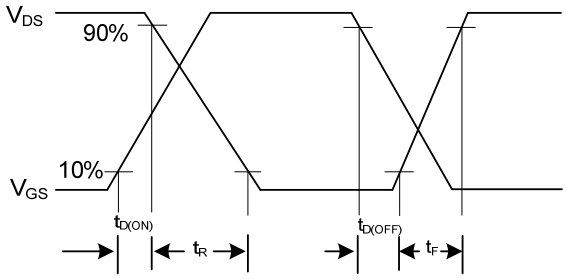


Peak Diode Recovery dv/dt Waveforms

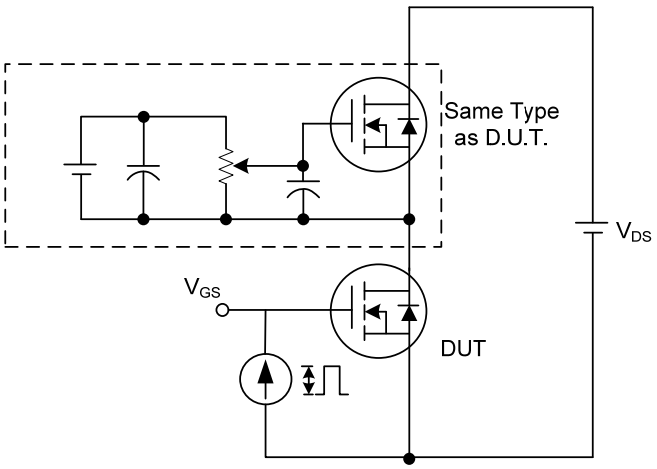
■ TEST CIRCUITS AND WAVEFORMS



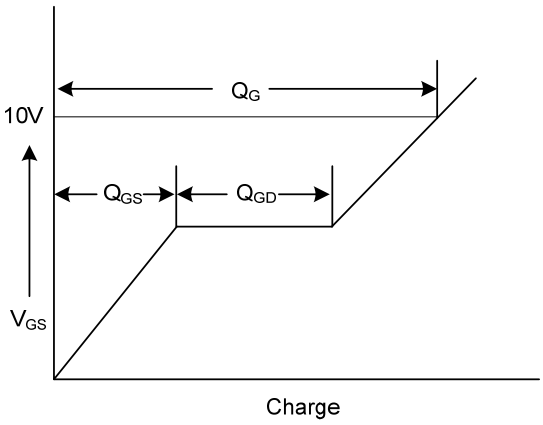
Switching Test Circuit



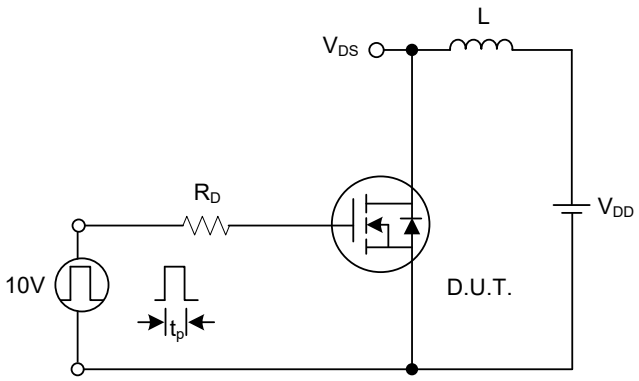
Switching Waveforms



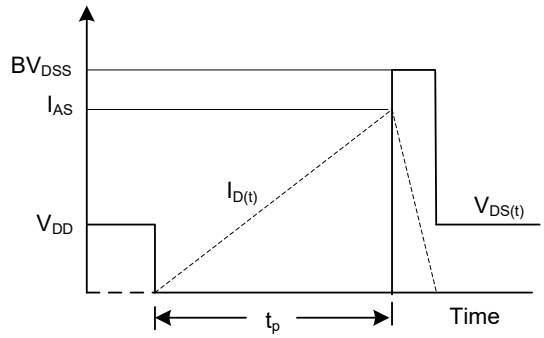
Gate Charge Test Circuit



Gate Charge Waveform



Unclamped Inductive Switching Test Circuit



Unclamped Inductive Switching Waveforms